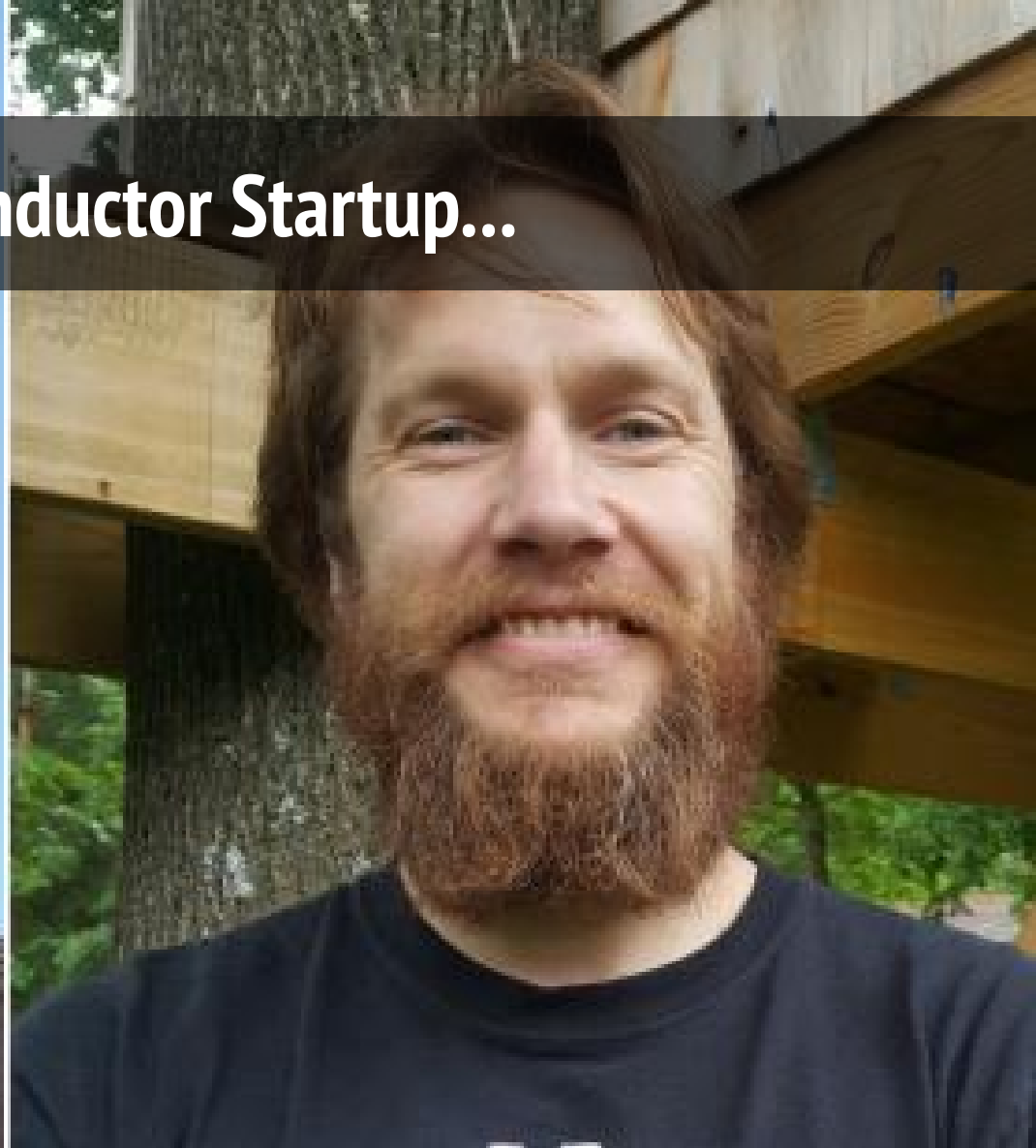


Computing in the Post-Moore Era

by Andreas Olofsson



Before & After Semiconductor Startup...



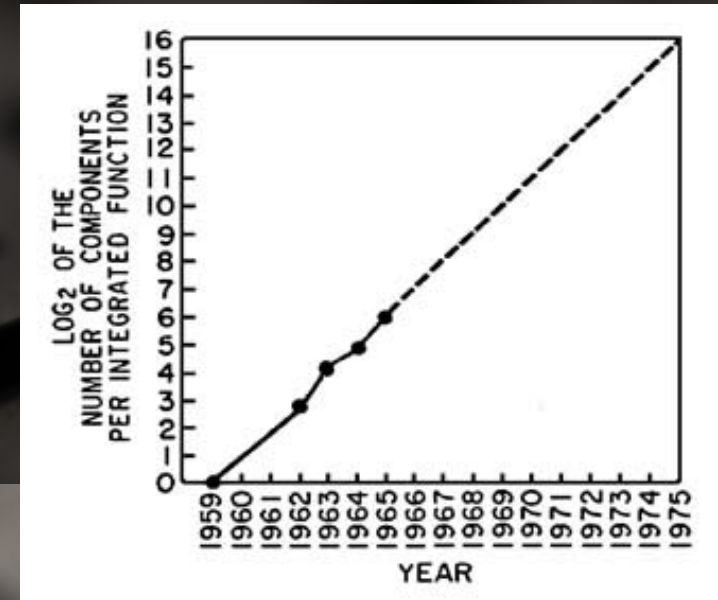
Talk Outline

- Moore's Law Primer
- Moore's Law Impact
- Predicting the Future (provided ASIS)

Moore's Law Definition

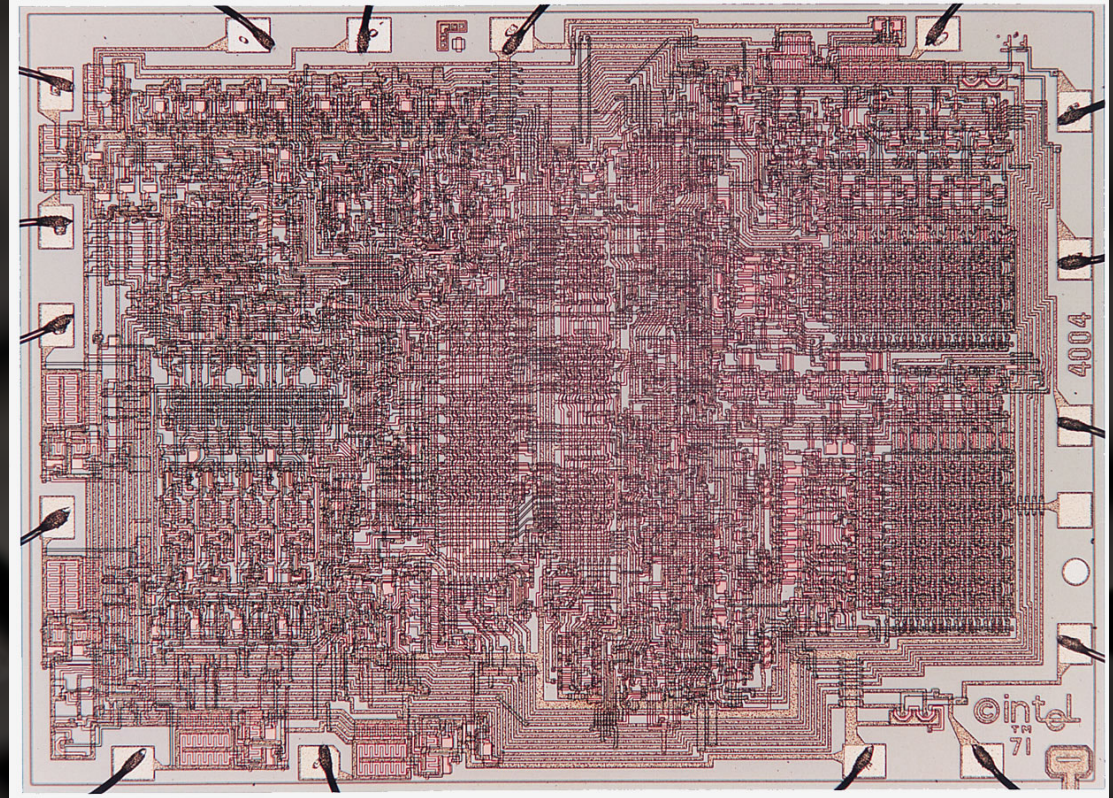
“ *The observation that the number of transistors in a dense integrated circuit doubles approximately every two years.* ”

- All about the \$\$\$
- Since 1955 cost/xtor reduced by 10B
- Don't confuse with performance!
- Profound societal impact



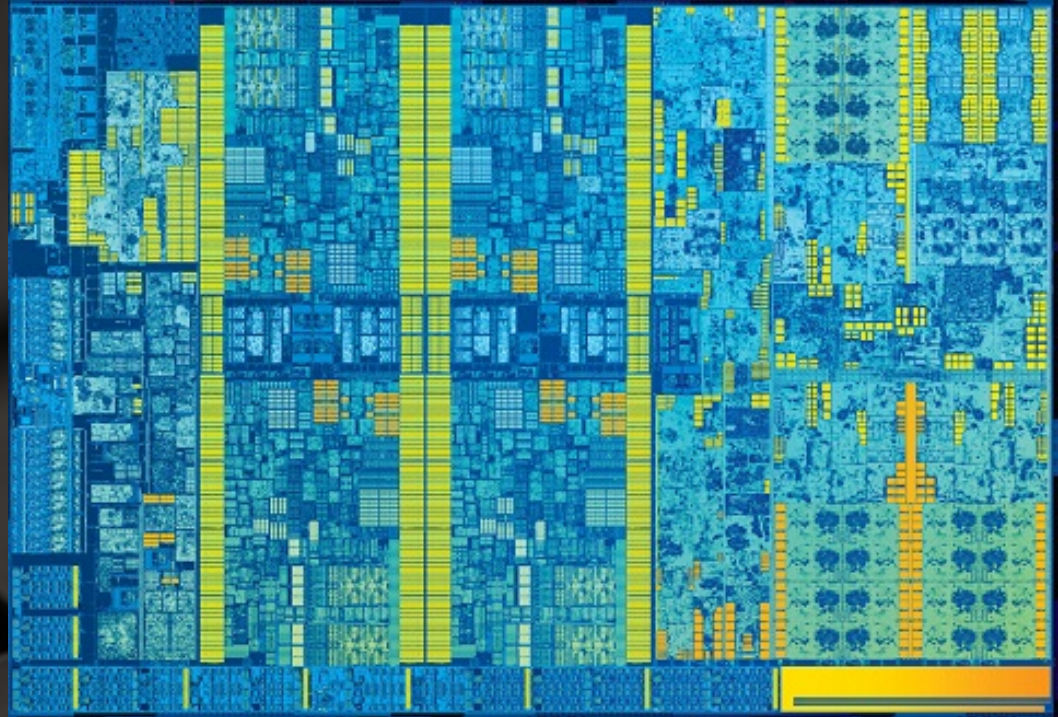
Moore's Law in 1971

- Intel 4004
- 1 core
- 2,300 xtors
- 12mm^2
- 740Khz
- 4-bit processor
- 10um process

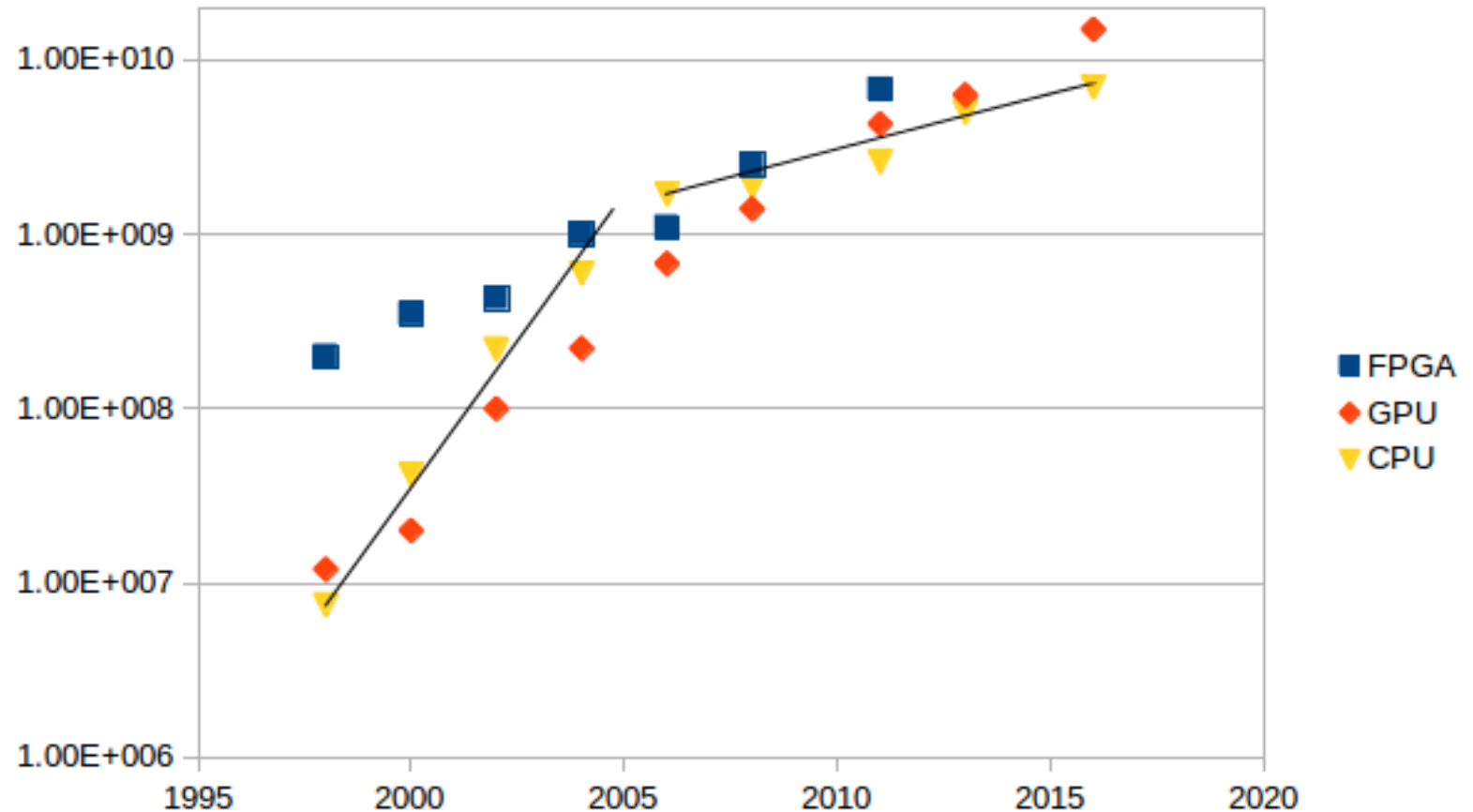


Moore's Law in 2016

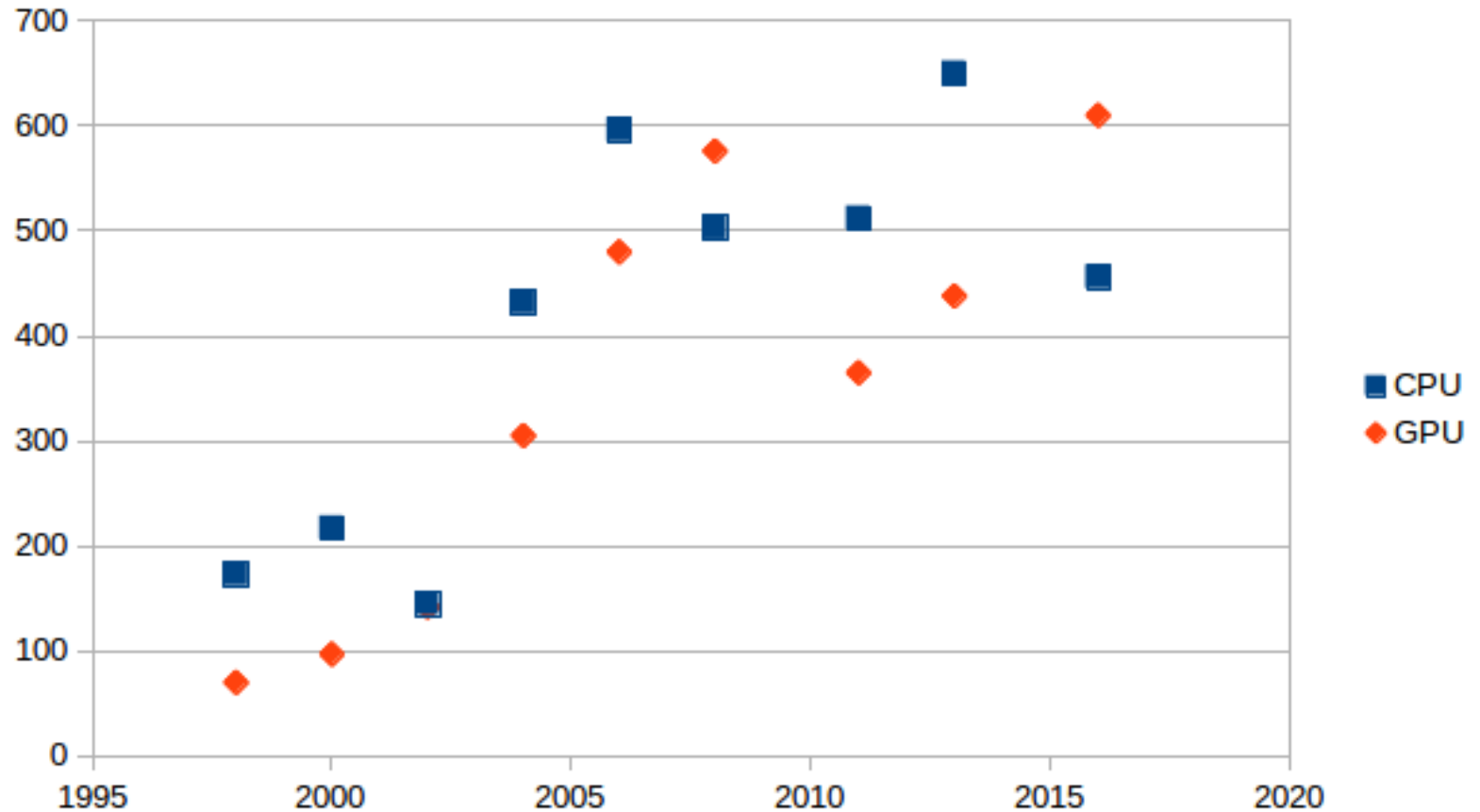
- Intel Broadwell
- 22 cores
- 7B xtors
- 456mm²
- 4 GHz
- 64-bit processor
- 14nm process (Picture shows Skylake)



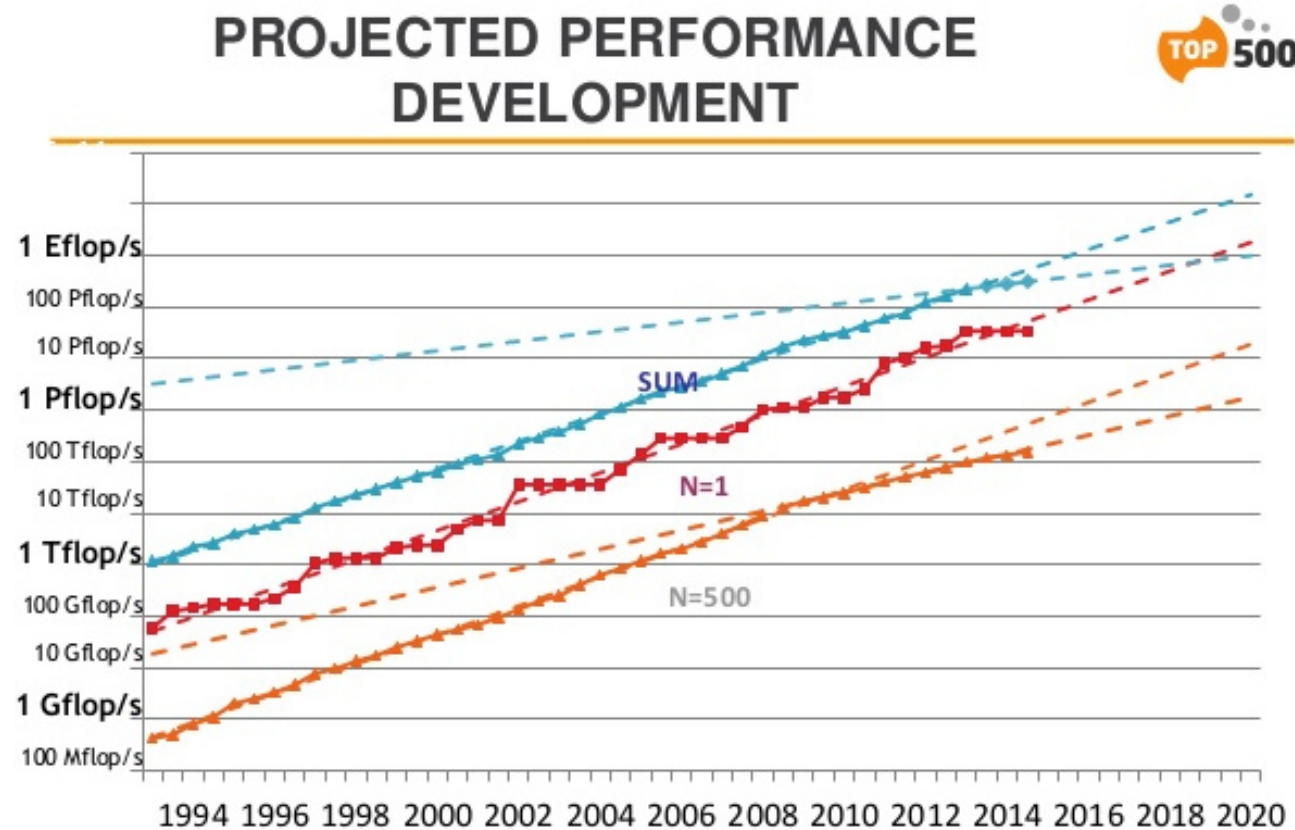
Moore's Law Transistor Trend



Moore's Law Area Trend



Moore Effect: Performance



Moore Effect: Cost

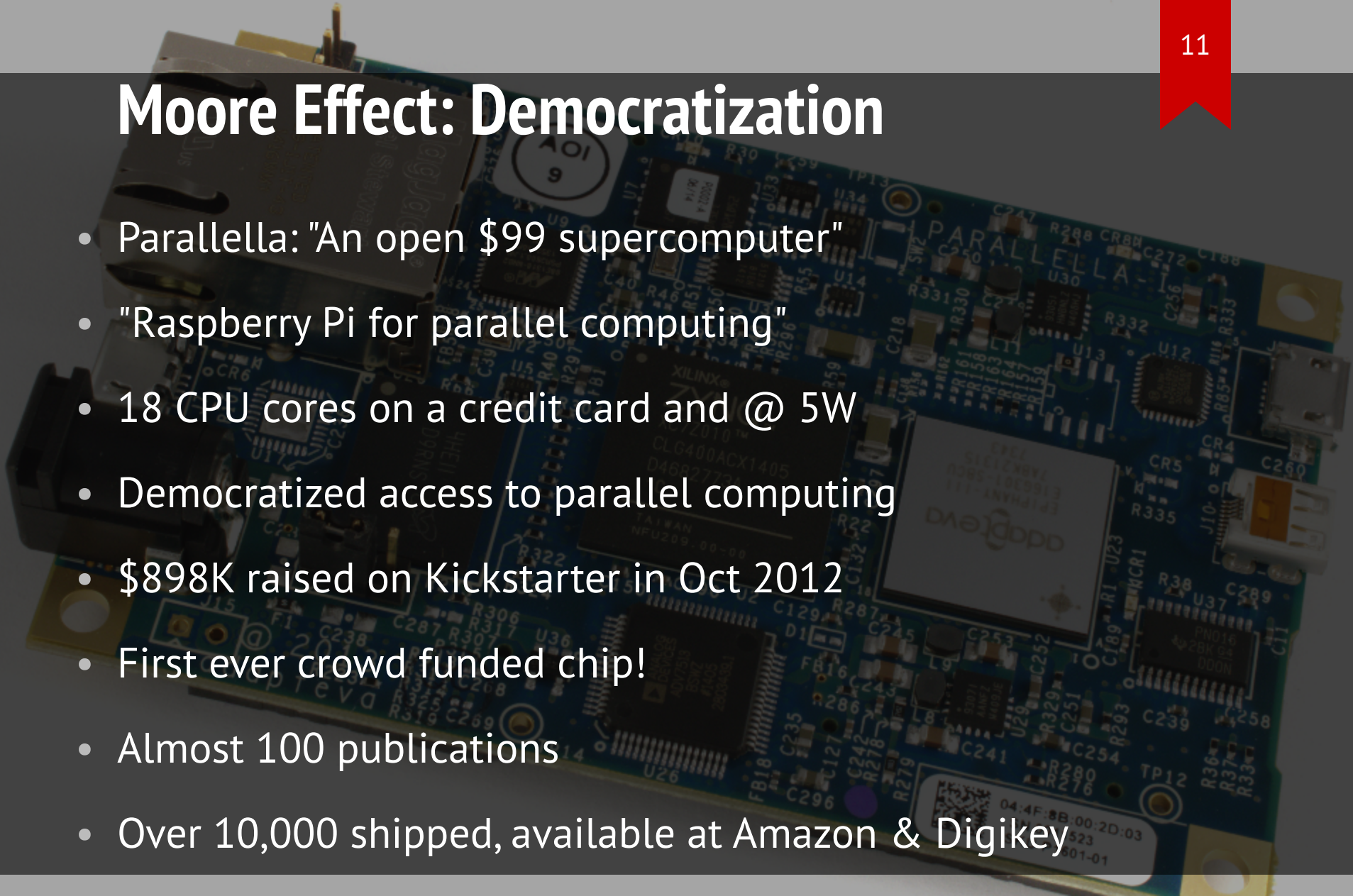
“ 2 Billion people with Thinking machines in their pockets

- 100 GFLOPS smart-phones possible
- 5-50B transistors per phone
- Exaflop level connected clouds



Moore Effect: Democratization

- Parallella: "An open \$99 supercomputer"
- "Raspberry Pi for parallel computing"
- 18 CPU cores on a credit card and @ 5W
- Democratized access to parallel computing
- \$898K raised on Kickstarter in Oct 2012
- First ever crowd funded chip!
- Almost 100 publications
- Over 10,000 shipped, available at Amazon & Digikey



Moore Effect: Casualties

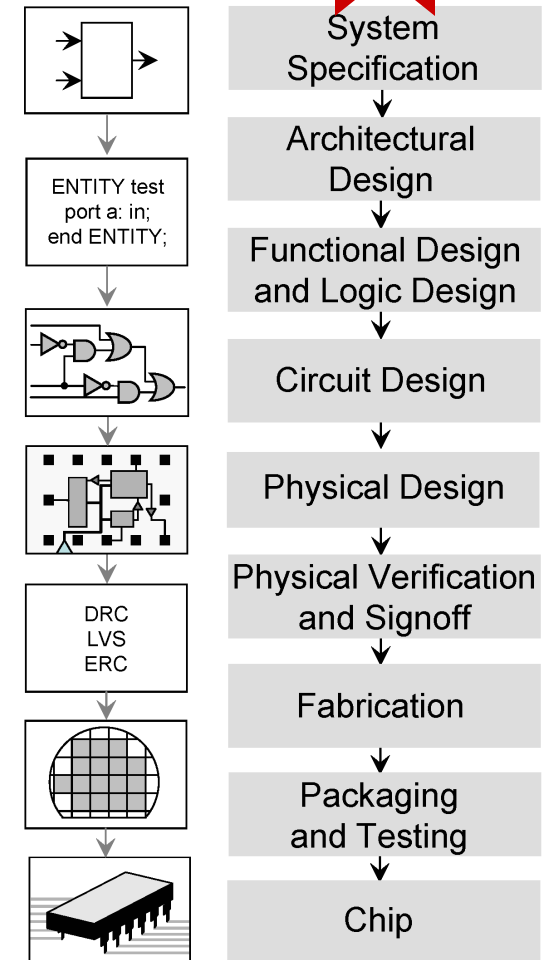
Achronix	Brightscale	Cradle	Mathstar	Sandbridge
Adapteva	Calxeda	C-Switch	Mobileye	Silicon Sp.
Ambric	Chameleon	ElementCXI	Monarch	Stream Proc
Asocs	Clearspeed	Greenarrays	Octasic	Stretch
Aspex	Cognivue	Icera	Picochip	Tilera
Axis Semi	Coherent L.	Intelliasys	Plurality	Transputer
BOPS	IBM-Cell	IP-flex	PACT	XMOS
Boston C.	CPUTech	Larrabee	Quicksilver	Zilabs

A close-up, macro photograph of a microchip or integrated circuit. The chip is dark and rectangular, with a grid of square pads visible. One pad in the lower right area is highlighted in a bright yellow color. The background is blurred, showing more of the chip's surface.

Chip Design 101

Chip Design Flow

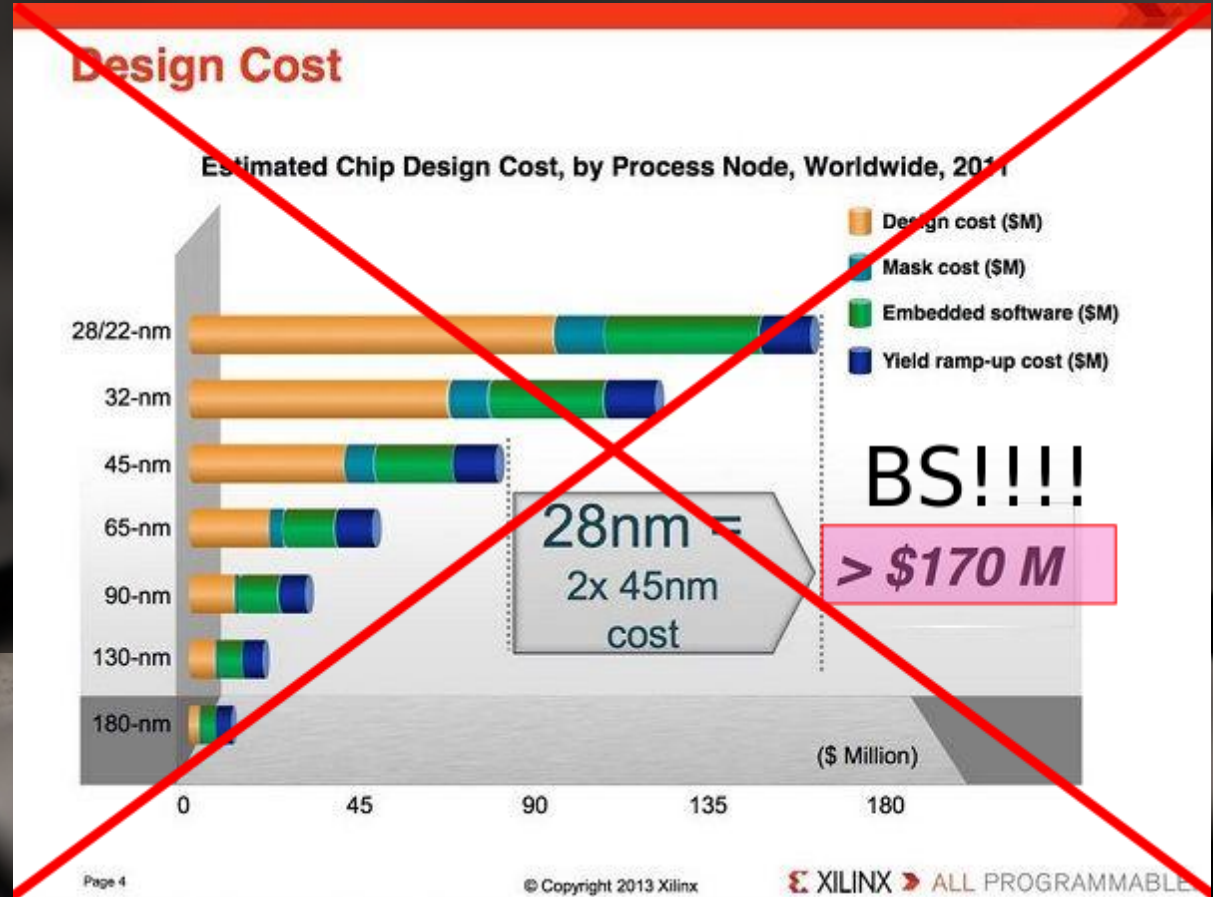
- ~1 cent / million logic gates
- Arcane languages (Verilog / VHDL)
- 1 year compilation cycle
- \$1M / compiler seat
- \$1M / hardware bug
- Completely opaque and proprietary flow



Don't believe the hype!

Adapteva's Story...

- 4 chips in 2 years
- 1-3 engineers
- <\$2M spent
- Complexity==\$\$\$



Real Chip Design Costs

Engineering	$N * (\$150K/eng)$
IP Licensing	\$1-10M
EDA Tools (Compilers)	\$1-10M
Tapeout (Tooling)	\$5M
Chip packaging	\$50K
Qualification	\$1M
<i>TOTAL</i>	<i>\$1-\$1,000M</i>

Moore's Law Economic Challenges

Challenge	Industry	Hurdle	Current	Future
Open source chip IP	\$5B	NIH	\$1M+	\$0
Open source EDA	\$6B	Complexity	\$1M+	\$0
Engineering	--	Time	9 months	24hrs
Packaging	\$13B	Logistics	\$50K	\$0
Manufacturing	\$40B	Logistics	\$2M+	\$1,000*

Post-Moore Predictions

- Laws of physics prevail (again)
- Semiconductor goes 3D (again)
- Silicon efficiency becomes important (again)
- Optimization engineering becomes important (again)
- Programming gets hard (again)
- ASICs will make a comeback (again)
- Parallel architectures win!

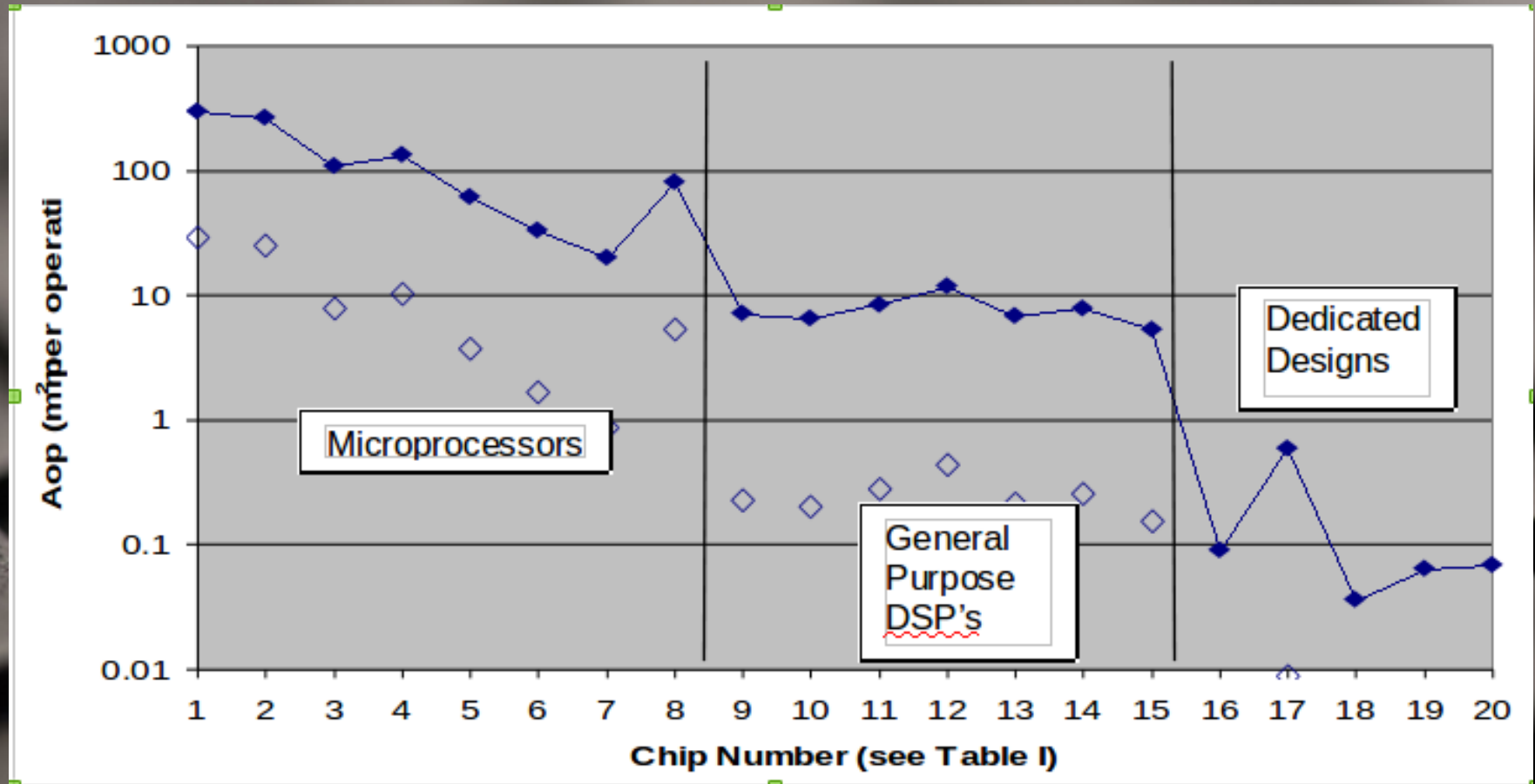
Physics: Getting Harder!

- Digital Power $\sim \text{cap} \times \text{voltage}^2 \times \text{freq}$ (derived)
- Switching Delay $\sim \text{resistance} \times \text{capacitance}$
- Speed Limit = 3×10^8 m/s (how far is one nanosecond?)
- Atomic Size Limit $\sim 0.1\text{nm}$
- Cooling $\sim \text{Area} \times dT \times HC(v)$
- Thermal Noise $\sim \text{FUNC}(\text{RES}, \text{temp}, V)$

3D: Easy! Plenty of Room at the Bottom

Rule	Value
Chip wire pitch	~0.1um
2.5D wire pitch	4um
Wirebond pitch	30um
2.5D Bump pitch	45um
Flip-chip pitch	170um
BGA pitch (advanced)	400um
Ethernet connector	~10,000um

Silicon Efficiency (REF: Brodersen)



Optimization Engineering

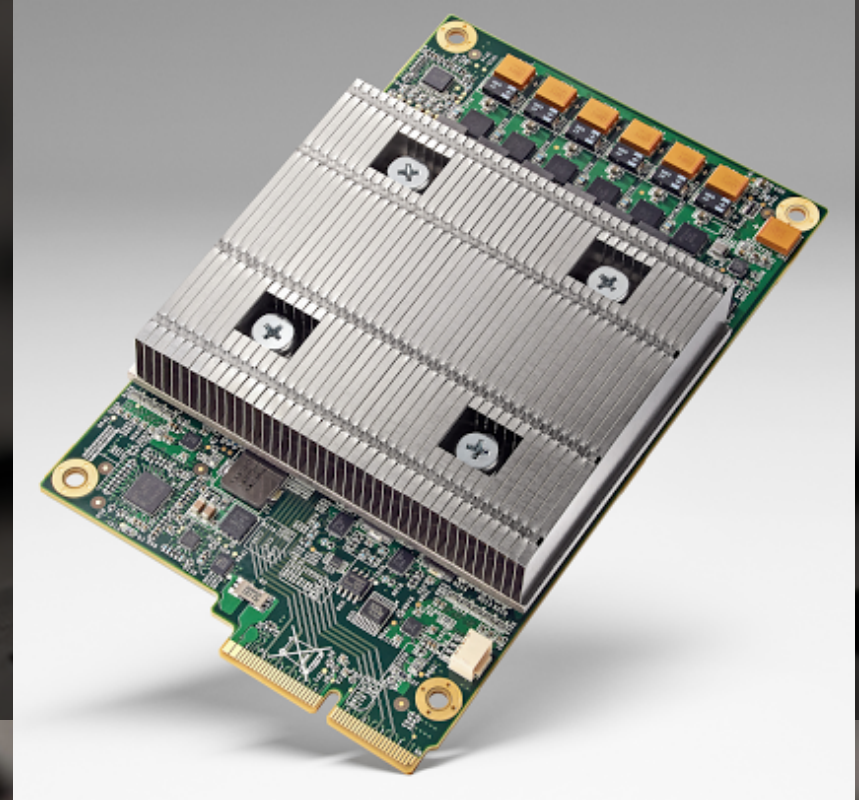
- 200,000 difference between unoptimized Java and assembly
- As things slow down, there is more time for optimization
- Engineers innovate when they have to (free lunch is over)
- Architecture convergence makes optimization effective
- Open source trend making a big difference

Programming Challenges

Metric	Chip Designer	Programmer
Correctness	Always	Always
Performance	Always	Sometimes*
Parallelism	Always	Sometimes*
Timing	Always	Sometimes
Size, Power	Always	Sometimes*
Fault-tolerance	Often	Rarely*

ASICs Making a Comeback

- Tail that wags the dog
- Can't leave 100X on the table
- Design cheaper than ever
- Cisco, Ericsson, Huawei
- Apple (A9x)
- Google (TPU)



The long tail of electronics

“*“Axiom: Big semiconductor companies only cares about big \$\$”*

...but what about low volume designs (1-100K units)?

- Health (diagnostics, embedded)
- Robotics (smarter, smaller)
- Communication (free and pervasive)
- Special supercomputers (to answer really tough questions)

Parallel Computing Will Win Eventually!

(Computing normalized for silicon area at 14/16FF)

Metric	GPU	CPU	Epiphany Arch
Performance(FLOPS)	5,300	500	10,000
Area (mm ²)	610	456	600
Power(W)	300+150	150	120